Cavity Technical Specification

IWLC2010 WG3 industrialization session
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contents;

- 1. Guide-line of the technical specification
- 2. Performance specification
- 3. Procedure specification
- 4. Plug Compatibility in the specification
- 5. High-pressure-vessel Regulation
- 6. Cost down

1. Guide-line of the technical specification

(1) Baseline: TESLA cavity with ILC-short length+ TTF-III coupler

*Baseline of Tuner: will be decided later,
after performance & cost comparison

- (2) Performance: need to describe RF, thermal, Mechanical, Electrical -performance
- (3) Procedure: need to describe Fabrication, Treatment, Inspection, Test Procedure
- (4) Plug-compatibility: describe clear boundary definition
- (5) High-pressure-vessel Regulation: need to describe how to clear it

2. Performance specification

We have "specification table" which will be a start point.

cavity	specification item	specification	unit and comments	further comments
	Frequency	1.30	GHz	
	Number of cells	9.00	cells	
	Gradient	31.50	MV/m	operational
		35.00	MV/m	Vertical test
	Q0	0.80	10^10	at 35
RF properties		1.00	10^10	at 31.5
	UOM domning		Q	decide later
	HOM damping		R/Q	decide later
	Short range wake			decide later
	Operating			
	temperature	2.00	K	
	Length	1247	mm	TESLA-short length
				must be compatible with
	Aperture		mm	beam dynamics
	Alignment accuray	300.00	um	rms
	Material	Niobium		
	Wall thickness	2.80	mm	
	Stiffness			decide later
	Flange/Seal system		Material	decide later
	Maximum			
Physical properties	overpressure			
		2	bar	
	Lorentz force			
	detuning over Flat-			_
	top at 35 MV/m	1.00	kHz	maximum
				Mag shield outside,
	0. (200.00		decide later for precise
	Outer diameter He	230.00	mm(inner diameter)	number
	vessel			KEK Mag shield inside,
		220.00	mm/inner diemeter\	decide later for precise number
	Magnetic chielding	230.00	mm(inner diameter) inside/outside	decide later
	Magnetic shielding		แเอเนย/บนเอเนย	ueciue iatei

^{*} yellow boxes indicate 'not fixed'

tuner	specification item	specification	unit and comments	further comments
	Tuning range	>600	kHz	
	Hysteresis in Slow tuning	<10	μm	
	Motor requirement	step-motor use, Power-off Holding, magnetic shielding		
	Motor specification	ex) 5 phase, xxA/phase,	match to driver unit, match to connector pin asignment,	decide later
	Motor location	insdie 4K? / outside 300K? / inside 300K accessible from outside?	need availability discussion, MTBF	decide later
Slow tuner	Magnetic shielding	<20	mG at Cavity surface, average on equater	
	Heat Load by motor	<50	mW at 2K	
	Physical envelope	do not conflict with GRP, 2-phase line, vessel support, alignment references, Invarrod, flange connection,		cable connection, Mag shield
	Survive Frequency Change in Lifetime of machine	~20 Mio. steps	could be total number of steps in 20 years,	

	Tuning range	>1	kHz over flat-top at 2K	
Fast tuner	Lorentz detuning residuals	<50	Hz at 31.5MV/m flat- top	(LD and microphinics? or LD only?) :decide later
	Actuator specification	ex) low voltage piezo 0-1000V,	match to driver unit, match to connector pin asignment,	decide later
	Actuator location	insdie 4K?/inside 4K accessible/inside 100K? accesible / inside 300K accessible from outside?		decide later
	Magnetic shielding	<20	mG at Cavity surface average	
	Heat Load in operation	<50	mW	
	Physical envelope	do not conflict with GRP, 2-phase line, vessel support, alignment references, Invarrod, flange connection,		
	Survive Frequency Change in Lifetime of machine	>10 ¹⁰	number of pulses over 20 years, (2x10 ⁹ :operational number)	

^{*} yellow boxes indicate 'not fixed'

Coupler	condition	specification unit and comments	further comments
Power requirements	Operation	>400 kW for 1600 us	
	Processing	>1200kW upto 400 us	need after vac break, cool-down
		>600 kW larger than 400 us	need after vac break, cool-down
rower requirements	Processing		
	with reflection		
	mode	>600 kW for 1600us	in Test stand
Processing time	warm	<50 hours	after installation, definition of power/pulse_width target are the same as 'Power Requirement' above.
	cold	<30 hours	after installation, definition of power/pulse_width target are the same as 'Power Requirement' above.
	2K static	< 0.063 W	
	5K static	< 0.171 W	depend on tunability
	40 K static	< 1.79 W	
Heat loads /coupler	2K dynamic	< 0.018 W	
	5K dynamic	< 0.152W	
	40K dynamic	< 6.93 W	
Cavity vacuum	# of windows	2	
integrety	bias capablity	yes	
DE Duamantia	Qext	Yes tunable	
RF Properties	Tuning range	1-10 10^6 if tunable	
	Position	compatible to TTF-III	decide later
Physical envelope	Flange	compatible to TTF-III	decide later (to cavity, to cryostat)
	waveguide	compatible to TTF-III	decide later
	support	compatible to TTF-III	decide later
Instrumentation	vacuum level	>= 1	
	spark detection	0at window	
	electron current detection temperature	>= 1 at coax >= 1 at window	

^{*} yellow boxes indicate 'not fixed'

3. Procedure specification

(0) Flow-chart of cavity fabrication, treatment, inspection, and testing

Fabrication Procedure

Need to consider to follow XFEL

- (1) Material specification: Nb, Nb-Ti alloy, and Ti
- (2) Machining procedure: Nb, Nb-Ti alloy, and Ti
- (3) Pressing procedure
- (4) Treatment (handling, cleaning, etching) during fabrication
- (5) Welding procedure: Nb, Nb-Ti alloy, and Ti
- (5) Dumbbell fabrication procedure
- (6) End-group fabrication procedure
- (7) Welding up into cavity
- (8) Inspection specification (material scan, dimension, surface, frequency, leakage, etc)
- (9) Helium Tank fabrication, welding to cavity
- (10) Tools and equipment
- (11) Laboratory responsibilities

Treatment Procedure

- (1) Cavity handling specification
- (2) EP treatment specification
- (3) Rinsing treatment specification
- (4) Heat treatment specification
- (5) Tuning specification for 9-cell filed, straightness and HOM notch frequency
- (6) Surface inspection procedure
- (7) Surface repair procedure
- (8) Clean-room handling procedure
- (9) Attachment parts specification (Flange, gasket, antenna, pickup, etc)
- (10) Tools and equipment for treatment
- (11) Laboratory responsibilities

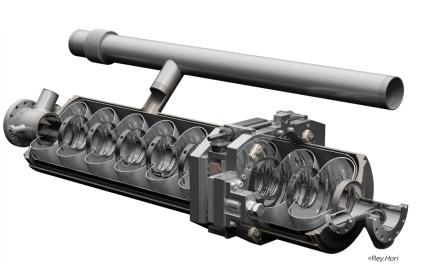
Test Procedure (Vertical Test)

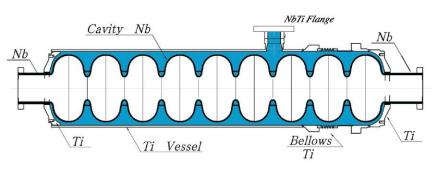
- (1) Vertical Test procedure
- (2) Support fixture specification
- (3) Cryostat specification
- (4) Instrumentation specification
- (5) Tools and equipment
- (6) Laboratory responsibilities

4. Plug Compatibility in the specification

We have "Plug-compatibility specification" which will be a start point.

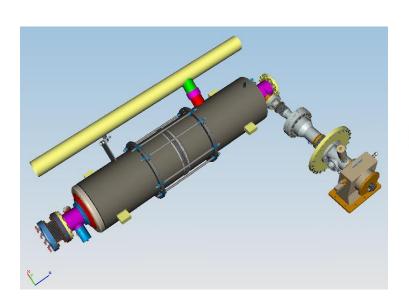
Plug compatible conditions at Cavity package

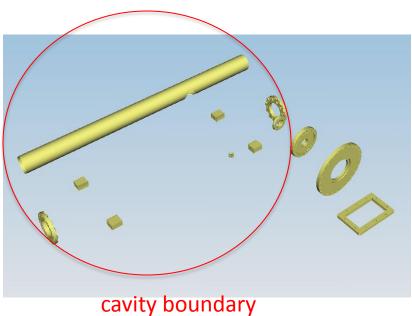




Item	Can be flexible	Plug- compatible
Cavity shape	TESLA / LL / RE	
Length		Required
Beam pipe dia		Required
Flange		Required
Tuner	blade/ sli de-jack	
Coupler flange		Required
He-in-line joint		Required

Cavity boundary

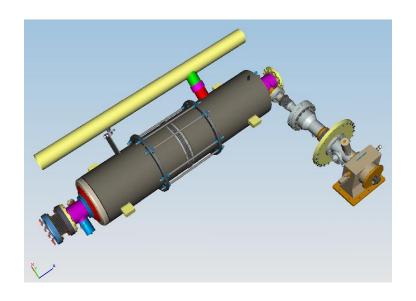


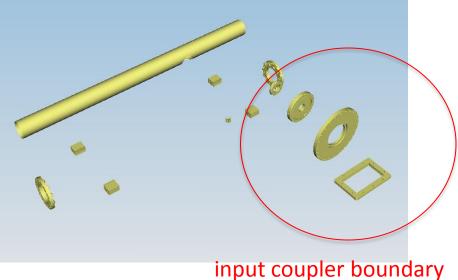


- (1) beam pipe port flange
- (2) coupler port flange
- (3) 4 support tabs
- (4) He pipes

Input coupler boundary

BCD: TTF3 coupler



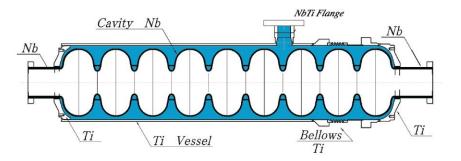


- (1) cavity port flange
- (2) cold/warm part interface flange
- (3) cryostat vessel flange
- (4) waveguide flange

5. High-pressure-vessel Regulation

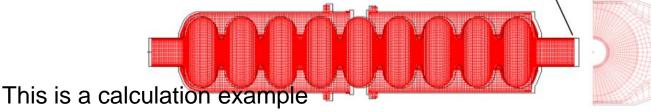
Regulation application for only cavity helium vessel

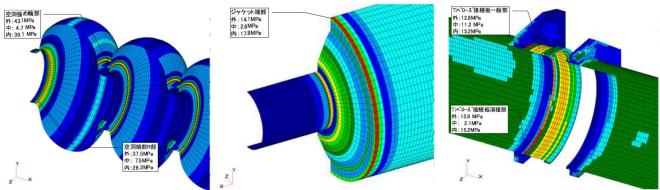
-> small volume (small P*V value) made application more simple



Nb, Ti at 2K use; not a matter (KEK case)

Still we need to evaluate pressure-stress calculation, welding record and inspection, and pressure test.





6. Cost down

The specification should include a room for cost down.

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For example; (Just an idea)

Make Nb material -> 2.8mm sheet

and make cell by press,

make pipes by deep-drawing and burring.
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Make Nb HOM antenna by press-cut from sheet material, Make Nb-Ti flange by press-cut from sheet material,

Make number of welding minimum

Make machining minimum

Make one parts fabrication in one company
Make press-cut process in the material company

Development of cavity technical specification document

Need to develop;

Flow-chart of cavity fabrication, treatment, Inspection and testing, Industry fabrication model.

Need decision of open column of the specification table.

Then, we can start writing down the document.